PFR Polypropylene Film/Foil, Radial



Overview

The PFR Series is a capacitor with polypropylene film and metal foil electrodes, encapsulated in self-extinguishing resin in a box of material meeting the requirements of UL 94 V-0.

Applications

Typical applications include high speed applications requiring low losses at high frequencies and high dV/ dt, such as electrical ballasts, televisions, video and telecommunications.

Benefits

• Rated voltage: 63 - 1,000 VDC Rated voltage: 40 – 250 VAC

Capacitance range: 0.0001 – 0.022 μF

· Lead spacing: 5 mm

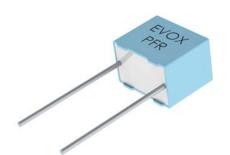
• Capacitance tolerance: ±1%, ±2%, ±2.5%, ±5%, ±10%

Climatic category: 55/100/56, IEC 60068-1

Tape & Reel packaging in accordance with IEC 60286-2

· RoHS Compliant and lead-free terminations

Category temperature range of -55°C to +100°C



Customer Part Number

PFR	5	101	J	63	J11	L4BULK
Series	Lead Spacing (mm)	Capacitance Code (pF)	Capacitance Tolerance	Rated Voltage (VDC)	Size Code	Packaging
Polypropylene Film/ Foil	5 (Standard)	First two digits represent significant figures. Third digit specifies number of zeros.	F = ±1% G = ±2% H = ±2.5% J = ±5% K = ±10%	63 = 63 100 = 100 250 = 250 400 = 400 630 = 630 1000 = 1,000	See Dimension Table	See Ordering Options Table

KEMET Internal Part Number

F	411	J	Н	101	J	063	С
Capacitor Class	Series	Lead Spacing (mm)	Size Code	Capacitance Code (pF)	Capacitance Tolerance	Rated Voltage (VDC)	Packaging
F = Film	Polypropylene Film/Foil	J = 5.0	See Dimension Table	First two digits represent significant figures. Third digit specifies number of zeros.	F = ±1% G = ±2% R = ±2.5% J = ±5% K = ±10%	063 = 63 100 = 100 250 = 250 400 = 400 630 = 630 1K0 = 1,000	See Ordering Options Table

One world. One KEMET

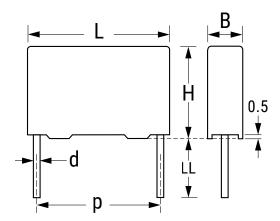
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Ordering Options Table

Lead Spacing Nominal (mm)	Type of Leads and Packaging	Lead Length (mm)	KEMET Lead and Packaging Code	Legacy Lead and Packaging Code
	Standard Lead and Packaging Options			
	Bulk (Bag) – Short Leads	4 +1/-0	С	L4BULK
	Tape & Reel (Standard Reel F 360 mm)	$H_0 = 18.5 \pm 0.5$	L	L16.5TR18
5	Other Lead and Packaging Options			
	Ammo Pack	$H_0 = 16.5 \pm 0.5$	Q	L16.5TA16
	Ammo Pack	$H_0 = 18.5 \pm 0.5$	R	L16.5TA18
	Tape & Reel (Large Reel F 500 mm)	$H_0 = 18.5 \pm 0.5$	Р	L16.5LR18

Dimensions - Millimeters



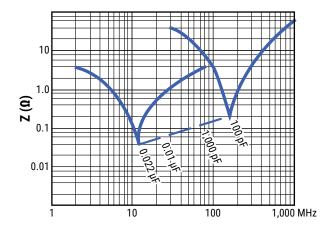
KEMET Size Le Code	Legacy Size Code	р		В		Н		L		d			
		Nominal	Tolerance										
JH	J11	5	-0.4	4.5	Maximum	6	Maximum	7.2	Maximum	0.5	±0.05		
JK	J12	5	-0.4	5.5	Maximum	7	Maximum	7.2	Maximum	0.5	±0.05		
JR	J13	5	-0.4	6.5	Maximum	8	Maximum	7.2	Maximum	0.5	±0.05		
	Note: See Ordering Options Table for lead length (LL) options.												



Performance Characteristics

Voltage Range (VDC)	63	100	250	400	630	1,000					
Voltage Range (VAC)	40	63	160	220	250	250					
Capacitance Range (μF)	0.0001 - 0.022	0.0001 - 0.01	0.0001 - 0.0068	0.0001 - 0.0068	0.0001 - 0.0047	0.0001 - 0.001					
Capacitance Values	In accordance wi	th IEC E12 series									
Capacitance Tolerance	±1%, ±2%, ±2.5%,	±5%, ±10%									
Category Temperature Range	-55°C to +100°C. KEMET for detail		erature up to +105°(C is allowed under c	ertain conditions. Pl	ease consult					
Climatic Category	IEC 60068-1, 55/	100/56									
Capacitance Drift	Maximum 0.3% a 40% to 60%	Maximum 0.3% after a 2 year storage period at a temperature of +10°C to +40°C and a relative humidity of 10% to 60%									
Temperature Coefficient	-200 (+50, -100)	ppm/°C at 1 kHz									
Self-Inductance	Approximately 6	nH/cm for the total	length of capacitor	winding and the lea	ds						
			Maximum V	alues at +23°C							
		C ≤ 0.001 µF	0.001 μF < C	≤ 0.0047 μF	C > 0.0)047 μF					
Dissipation Factor tanδ	1 kHz	0.0004	0.0	004	0.0	0004					
	10 kHz	0.0004	0.0	005	0.0	007					
	100 kHz	0.0005	0.0	007		-					
		Me	easured at +20°C, ac	cording to IEC 6038	34-13						
Insulation Resistance		Between Terminals:									
			≥ 100	,000 ΜΩ							
Insulation Resistance	Between Terminals: ≥ 100,000 MΩ										

Resonance Frequencies





Environmental Test Data

Test	IEC Publication	Procedure	Requirements
Voltage Proof	60384-1 Clause 4.6	1.6 x V _R after 60 seconds	The capacitors must withstand the voltage without breakdowns or flashovers and without decreased insulation resistance below the value in each detail specification. No visible damage
	Clause 4.6 2.3	$2 \times V_R$ (minimum 400 VDC to case) after 60 seconds	As above
Vibration	60068-2-6 Test Fc	6 hours with 10 – 500 Hz and 0.75 mm amplitude or 98 m/s² depending on frequency	No visible damage $\tan\delta \le 1.2$ x stated value at 100 kHz Δ C/C $\le \pm 0.5\%$
Bump	60068-2-29 Test Eb	4,000 bumps with 390 m/s² mounted on PCB	Δ C/C ≤ ±0.5% tanδ ≤ 1.2 x stated value at 100 kHz Insulation resistance: ≥ 100,000 MΩ for C _R ≤ 0.33 μF ≥ 30,000 MΩ, μF for C _R > 0.33 μF
Resistance to Soldering Heat	60068-2-20 Method 1A	Solder bath at + 260°C ±5°C with screening	Immersion of the terminations into the solder bath shall be completed in a time not exceeding 1 second and the terminations shall remain immersed to the specified depth for 10 + 1 second and then be withdrawn. $\Delta \ C/C \le \pm 1.0\%$ tan δ increase < 0.001 No visible damage
Climatic Sequence	60384–1 Paragraph 4:21	60068-2.2 dry heat 16 hours 60068-2-34 damp heat, one cycle 60068-2-1 Test Aa 2 hours	Insulation resistance: $\geq 100,000 \text{ M}\Omega \text{ for } C_R \leq 0.33 \mu\text{F}$ $\geq 30,000 \text{ M}\Omega, \mu\text{F for } C_R > 0.33 \mu\text{F}$ $\Delta \text{ C/C} \leq \pm 0.5\%$ $\tan\delta \leq 1.2 \text{ x stated value at } 100 \text{ kHz}$
Damp Heat Steady State	60068-2-3 Test Ca	+40°C and 90 - 95% RH	56 days no visible damage Insulation resistance: $\geq 50,000$ MΩ for $C_R \leq 0.33$ μF $\geq 15,000$ MΩ, μF for $C_R > 0.33$ μF Δ C/C $\leq \pm 1\%$ tanδ ≤ 1.2 x stated value at 100 kHz
Endurance, AC		1,000 hours at +85°C and 1.25 x $V_{_{\rm R}}$ AC	No visible damage $ \Delta \ C/C \le \pm 3\% $ $ \tan\delta \le 1.5 \ x \ stated \ value \ at \ 100 \ kHz $ Insulation resistance: $ \ge 100,000 \ M\Omega \ for \ C_R \le 0.33 \ \mu F $ $ \ge 30,000 \ M\Omega, \ \mu F \ for \ C_R > 0.33 \ \mu F $
Charge and Discharge	60384-17 Paragraph 4.13	10,000 pulses and with (2 x) dV/dt according to detail specification	tan δ (100 kHz) \leq 2 x stated value (100 kHz) Δ C/C \leq \pm 0.5% Insulation resistance: \geq 50,000 M Ω for C _R \leq 0.33 μ F \geq 15,000 M Ω • μ F for C _R > 0.33 μ F



Environmental Compliance

All KEMET pulse capacitors are RoHS Compliant.



Table 1 - Ratings & Part Number Reference

VDC	VAC	Cap Value (µF)	Maxim	um Dime in mm	ensions	Lead Spacing	dV/ dt (V/	Size Code (New/	New KEMET Part Number	Legacy Part Number
		(μr)	В	Н	ш	(p)	μs)	Legacy)	Part Number	Nullibel
63	40	0.00010	4.5	6.0	7.2	5	1,000	JH/J11	F411JH101(3)063(2)	PFR5101(1)63J11L4(2)
63	40	0.00015	4.5	6.0	7.2	5	1,000	JH/J11	F411JH151(3)063(2)	PFR5151(1)63J11L4(2)
63	40	0.00022	4.5	6.0	7.2	5	1,000	JH/J11	F411JH221(3)063(2)	PFR5221(1)63J11L4(2)
63	40	0.00033	4.5	6.0	7.2	5	1,000	JH/J11	F411JH331(3)063(2)	PFR5331(1)63J11L4(2)
63	40	0.00047	4.5	6.0	7.2	5	1,000	JH/J11	F411JH471(3)063(2)	PFR5471(1)63J11L4(2)
63	40	0.00068	4.5	6.0	7.2	5	1,000	JH/J11	F411JH681(3)063(2)	PFR5681(1)63J11L4(2)
63	40	0.0010	4.5	6.0	7.2	5	1,000	JH/J11	F411JH102(3)063(2)	PFR5102(1)63J11L4(2)
63	40	0.0015	4.5	6.0	7.2	5	1,000	JH/J11	F411JH152(3)063(2)	PFR5152(1)63J11L4(2)
63	40	0.0022	4.5	6.0	7.2	5	1,000	JH/J11	F411JH222(3)063(2)	PFR5222(1)63J11L4(2)
63	40	0.0033	4.5	6.0	7.2	5	1,000	JH/J11	F411JH332(3)063(2)	PFR5332(1)63J11L4(2)
63	40	0.0047	4.5	6.0	7.2	5	1,000	JH/J11	F411JH472(3)063(2)	PFR5472(1)63J11L4(2)
63	40	0.0068	4.5	6.0	7.2	5	1,000	JH/J11	F411JH682(3)063(2)	PFR5682(1)63J11L4(2)
63	40	0.010	5.5	7.0	7.2	5	1,000	JK/J12	F411JK103(3)063(2)	PFR5103(1)63J12L4(2)
63	40	0.015	6.5	8.0	7.2	5	1,000	JR/J13	F411JR153(3)063(2)	PFR5153(1)63J13L4(2)
63	40	0.020	6.5	8.0	7.2	5	1,000	JR/J13	F411JR203(3)063(2)	PFR5203(1)63J13L4(2)
63	40	0.022	6.5	8.0	7.2	5	1,000	JR/J13	F411JR223(3)063(2)	PFR5223(1)63J13L4(2)
100	63	0.00010	4.5	6.0	7.2	5	1,000	JH/J11	F411JH101(3)100(2)	PFR5101(1)100J11L4(2)
100	63	0.00015	4.5	6.0	7.2	5	1,000	JH/J11	F411JH151(3)100(2)	PFR5151(1)100J11L4(2)
100	63	0.00022	4.5	6.0	7.2	5	1,000	JH/J11	F411JH221(3)100(2)	PFR5221(1)100J11L4(2)
100	63	0.00033	4.5	6.0	7.2	5	1,000	JH/J11	F411JH331(3)100(2)	PFR5331(1)100J11L4(2)
100	63	0.00047	4.5	6.0	7.2	5	1,000	JH/J11	F411JH471(3)100(2)	PFR5471(1)100J11L4(2)
100	63	0.00068	4.5	6.0	7.2	5	1,000	JH/J11	F411JH681(3)100(2)	PFR5681(1)100J11L4(2)
100	63	0.0010	4.5	6.0	7.2	5	1,000	JH/J11	F411JH102(3)100(2)	PFR5102(1)100J11L4(2)
100	63	0.0015	4.5	6.0	7.2	5	1,000	JH/J11	F411JH152(3)100(2)	PFR5152(1)100J11L4(2)
100	63	0.0022	4.5	6.0	7.2	5	1,000	JH/J11	F411JH222(3)100(2)	PFR5222(1)100J11L4(2)
100	63	0.0033	5.5	7.0	7.2	5	1,000	JK/J12	F411JK332(3)100(2)	PFR5332(1)100J12L4(2)
100	63	0.0047	5.5	7.0	7.2	5	1,000	JK/J12	F411JK472(3)100(2)	PFR5472(1)100J12L4(2)
100	63	0.0068	6.5	8.0	7.2	5	1,000	JR/J13	F411JR682(3)100(2)	PFR5682(1)100J13L4(2)
100	63	0.010	6.5	8.0	7.2	5	1,000	JR/J13	F411JR103(3)100(2)	PFR5103(1)100J13L4(2)
250	160	0.00010	4.5	6.0	7.2	5	1,000	JH/J11	F411JH101(3)250(2)	PFR5101(1)250J11L4(2)
250	160	0.00015	4.5	6.0	7.2	5	1,000	JH/J11	F411JH151(3)250(2)	PFR5151(1)250J11L4(2)
250	160	0.00022	4.5	6.0	7.2	5	1,000	JH/J11	F411JH221(3)250(2)	PFR5221(1)250J11L4(2)
250	160	0.00033	4.5	6.0	7.2	5	1,000	JH/J11	F411JH331(3)250(2)	PFR5331(1)250J11L4(2)
250	160	0.00047	4.5	6.0	7.2	5	1,000	JH/J11	F411JH471(3)250(2)	PFR5471(1)250J11L4(2)
250	160	0.00068	4.5	6.0	7.2	5	1,000	JH/J11	F411JH681(3)250(2)	PFR5681(1)250J11L4(2)
VDC	VAC	Cap Value (µF)	B (mm)	H (mm)	L (mm)	Lead Spacing (p)	dV/dt (V/μs)	Size Code (New/Legacy)	New KEMET Part Number	Legacy Part Number

⁽¹⁾ $F = \pm 1\%$, $G = \pm 2\%$, $H = \pm 2.5\%$, $J = \pm 5\%$, $K = \pm 10\%$ for Legacy Part Number.

⁽²⁾ Insert lead and packaging code. See table for available options.

⁽³⁾ $F = \pm 1\%$, $G = \pm 2\%$, $R = \pm 2.5\%$, $J = \pm 5\%$, $K = \pm 10\%$ for New Kemet Part Number.



Table 1 - Ratings & Part Number Reference cont.

VDC	VAC	Cap Value (µF)	Maxim	um Dime in mm	ensions	Lead Spacing	dV/ dt (V/	Size Code (New/	New KEMET Part Number	Legacy Part Number	
		(рі)	В	Н	L	(p)	µs)	Legacy)	r art Number	Number	
250	160	0.0010	4.5	6.0	7.2	5	1,000	JH/J11	F411JH102(3)250(2)	PFR5102(1)250J11L4(2)	
250	160	0.0015	4.5	6.0	7.2	5	1,000	JH/J11	F411JH152(3)250(2)	PFR5152(1)250J11L4(2)	
250	160	0.0022	4.5	6.0	7.2	5	1,000	JH/J11	F411JH222(3)250(2)	PFR5222(1)250J11L4(2)	
250	160	0.0033	5.5	7.0	7.2	5	1,000	JK/J12	F411JK332(3)250(2)	PFR5332(1)250J12L4(2)	
250	160	0.0047	6.5	8.0	7.2	5	1,000	JR/J13	F411JR472(3)250(2)	PFR5472(1)250J13L4(2)	
250	160	0.0068	6.5	8.0	7.2	5	1,000	JR/J13	F411JR682(3)250(2)	PFR5682(1)250J13L4(2)	
400	220	0.00010	4.5	6.0	7.2	5	1,000	JH/J11	F411JH101(3)400(2)	PFR5101(1)400J11L4(2)	
400	220	0.00015	4.5	6.0	7.2	5	1,000	JH/J11	F411JH151(3)400(2)	PFR5151(1)400J11L4(2)	
400	220	0.00022	4.5	6.0	7.2	5	1,000	JH/J11	F411JH221(3)400(2)	PFR5221(1)400J11L4(2)	
400	220	0.00033	4.5	6.0	7.2	5	1,000	JH/J11	F411JH331(3)400(2)	PFR5331(1)400J11L4(2)	
400	220	0.00047	4.5	6.0	7.2	5	1,000	JH/J11	F411JH471(3)400(2)	PFR5471(1)400J11L4(2)	
400	220	0.00068	4.5	6.0	7.2	5	1,000	JH/J11	F411JH681(3)400(2)	PFR5681(1)400J11L4(2)	
400	220	0.0010	4.5	6.0	7.2	5	1,000	JH/J11	F411JH102(3)400(2)	PFR5102(1)400J11L4(2)	
400	220	0.0015	4.5	6.0	7.2	5	1,000	JH/J11	F411JH152(3)400(2)	PFR5152(1)400J11L4(2)	
400	220	0.0022	4.5	6.0	7.2	5	1,000	JH/J11	F411JH222(3)400(2)	PFR5222(1)400J11L4(2)	
400	220	0.0033	5.5	7.0	7.2	5	1,000	JK/J12	F411JK332(3)400(2)	PFR5332(1)400J12L4(2)	
400	220	0.0047	6.5	8.0	7.2	5	1,000	JR/J13	F411JR472(3)400(2)	PFR5472(1)400J13L4(2)	
400	220	0.0068	6.5	8.0	7.2	5	1,000	JR/J13	F411JR682(3)400(2)	PFR5682(1)400J13L4(2)	
630	250	0.00010	4.5	6.0	7.2	5	1,000	JH/J11	F411JH101(3)630(2)	PFR5101(1)630J11L4(2)	
630	250	0.00015	4.5	6.0	7.2	5	1,000	JH/J11	F411JH151(3)630(2)	PFR5151(1)630J11L4(2)	
630	250	0.00022	4.5	6.0	7.2	5	1,000	JH/J11	F411JH221(3)630(2)	PFR5221(1)630J11L4(2)	
630	250	0.00033	4.5	6.0	7.2	5	1,000	JH/J11	F411JH331(3)630(2)	PFR5331(1)630J11L4(2)	
630	250	0.00047	4.5	6.0	7.2	5	1,000	JH/J11	F411JH471(3)630(2)	PFR5471(1)630J11L4(2)	
630	250	0.00068	4.5	6.0	7.2	5	1,000	JH/J11	F411JH681(3)630(2)	PFR5681(1)630J11L4(2)	
630	250	0.0010	4.5	6.0	7.2	5	1,000	JH/J11	F411JH102(3)630(2)	PFR5102(1)630J11L4(2)	
630	250	0.0015	4.5	6.0	7.2	5	1,000	JH/J11	F411JH152(3)630(2)	PFR5152(1)630J11L4(2)	
630	250	0.0022	5.5	7.0	7.2	5	1,000	JK/J12	F411JK222(3)630(2)	PFR5222(1)630J12L4(2)	
630	250	0.0033	6.5	8.0	7.2	5	1,000	JR/J13	F411JR332(3)630(2)	PFR5332(1)630J13L4(2)	
630	250	0.0047	6.5	8.0	7.2	5	1,000	JR/J13	F411JR472(3)630(2)	PFR5472(1)630J13L4(2)	
1000	250	0.00010	4.5	6.0	7.2	5	1,000	JH/J11	F411JH101(3)1K0(2)	PFR5101(1)1000J11L4(2)	
1000	250	0.00015	4.5	6.0	7.2	5	1,000	JH/J11	F411JH151(3)1K0(2)	PFR5151(1)1000J11L4(2)	
1000	250	0.00022	4.5	6.0	7.2	5	1,000	JH/J11	F411JH221(3)1K0(2)	PFR5221(1)1000J11L4(2)	
1000	250	0.00033	5.5	7.0	7.2	5	1,000	JK/J12	F411JK331(3)1K0(2)	PFR5331(1)1000J12L4(2)	
1000	250	0.00047	5.5	7.0	7.2	5	1,000	JK/J12	F411JK471(3)1K0(2)	PFR5471(1)1000J12L4(2)	
1000	250	0.00068	5.5	7.0	7.2	5	1,000	JK/J12	F411JK681(3)1K0(2)	PFR5681(1)1000J12L4(2)	
1000	250	0.0010	6.5	8.0	7.2	5	1,000	JR/J13	F411JR102(3)1K0(2)	PFR5102(1)1000J13L4(2)	
VDC	VAC	Cap Value (µF)	B (mm)	H (mm)	L (mm)	Lead Spacing (p)	dV/dt (V/μs)	Size Code (New/Legacy)	New KEMET Part Number	Legacy Part Number	

⁽¹⁾ $F = \pm 1\%$, $G = \pm 2\%$, $H = \pm 2.5\%$, $J = \pm 5\%$, $K = \pm 10\%$ for Legacy Part Number.

⁽²⁾ Insert lead and packaging code. See table for available options.

⁽³⁾ $F = \pm 1\%$, $G = \pm 2\%$, $R = \pm 2.5\%$, $J = \pm 5\%$, $K = \pm 10\%$ for New Kemet Part Number.



Soldering Process

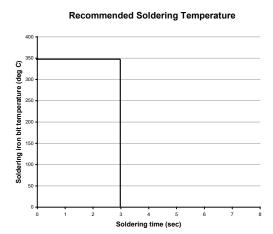
The implementation of the RoHS directive has resulted in the selection of SnAgCu (SAC) alloys or SnCu alloys as primary solder. This has increased the liquidus temperature from that of 183°C for SnPb eutectic alloy to 217 – 221°C for the new alloys. As a result, the heat stress to the components, even in wave soldering, has increased considerably due to higher pre-heat and wave temperatures. Polypropylene capacitors are especially sensitive to heat (the melting point of polypropylene is 160 – 170°C). Wave soldering can be destructive, especially for mechanically small polypropylene capacitors (with lead spacing of 5 mm to 15 mm), and great care has to be taken during soldering. The recommended solder profiles from KEMET should be used. Please consult KEMET with any questions. In general, the wave soldering curve from IEC Publication 61760-1 Edition 2 serves as a solid guideline for successful soldering. Please see Figure 1.

Reflow soldering is not recommended for through-hole film capacitors. Exposing capacitors to a soldering profile in excess of the above the recommended limits may result to degradation or permanent damage to the capacitors.

Do not place the polypropylene capacitor through an adhesive curing oven to cure resin for surface mount components. Insert through-hole parts after the curing of surface mount parts. Consult KEMET to discuss the actual temperature profile in the oven, if through-hole components must pass through the adhesive curing process. A maximum two soldering cycles is recommended. Please allow time for the capacitor surface temperature to return to a normal temperature before the second soldering cycle.

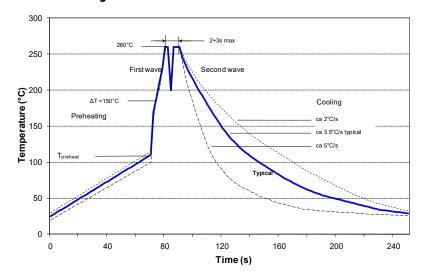
Manual Soldering Recommendations

Following is the recommendation for manual soldering with a soldering iron.



The soldering iron tip temperature should be set at 350°C (+10°C maximum) with the soldering duration not to exceed more than 3 seconds.

Wave Soldering Recommendations





Soldering Process cont.

Wave Soldering Recommendations cont.

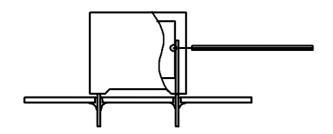
1. The table indicates the maximum set-up temperature of the soldering process Figure 1

Dielectric Film Material		imum Pre emperatu	Maximum Peak Soldering Temperature			
	Capacitor Pitch ≤ 10 mm	Capacitor Pitch = 15 mm	Capacitor Pitch > 15 mm	Capacitor Pitch ≤ 15 mm	Capacitor Pitch > 15 mm	
Polyester	130°C	130°C	130°C	270°C	270°C	
Polypropylene	100°C	110°C	130°C	260°C	270°C	
Paper	130°C	130°C	140°C	270°C	270°C	
Polyphenylene Sulphide	150°C	150°C	160°C	270°C	270°C	

2. The maximum temperature measured inside the capacitor:

Set the temperature so that inside the element the maximum temperature is below the limit:

Dielectric Film Material	Maximum temperature measured inside the element
Polyester	160°C
Polypropylene	110°C
Paper	160°C
Polyphenylene Sulphide	160°C



Temperature monitored inside the capacitor.

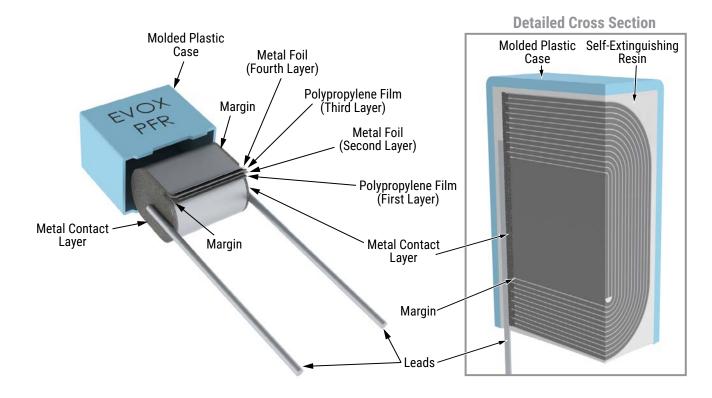
Selective Soldering Recommendations

Selective dip soldering is a variation of reflow soldering. In this method, the printed circuit board with through-hole components to be soldered is preheated and transported over the solder bath as in normal flow soldering without touching the solder. When the board is over the bath, it is stopped and pre-designed solder pots are lifted from the bath with molten solder only at the places of the selected components, and pressed against the lower surface of the board to solder the components.

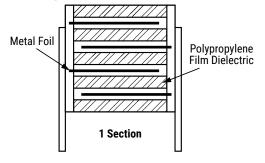
The temperature profile for selective soldering is similar to the double wave flow soldering outlined in this document, however, instead of two baths, there is only one bath with a time from 3 to 10 seconds. In selective soldering, the risk of overheating is greater than in double wave flow soldering, and great care must be taken so that the parts are not overheated.



Construction

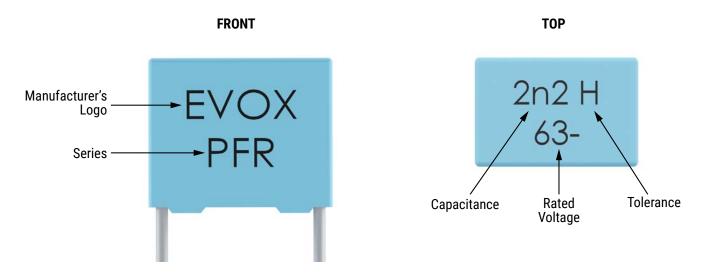


Winding Scheme





Marking

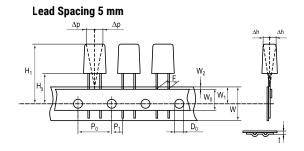


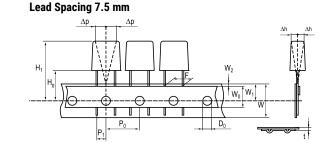
Packaging Quantities

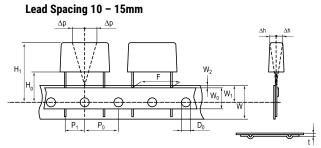
KEMET Size Code	Legacy Size Code	Lead Spacing	Thickness (mm)	Height (mm)	Length (mm)	Bulk Short Leads	Bulk Long Leads	Standard Reel ø 360 mm	Large Reel ø 500 mm	Ammo
JF	J01		2.5	6.5	7.2	2,000	2,000	2,500	5,000	3,000
JJ	J02		3.5	8	7.2	2,000	2,000	2,000	4,000	2,000
JL	J03		4.5	9	7.2	1,000	1,000	1,500	3,000	1,700
JQ	J04		5	10	7.2	1,000	1,000	1,300	2,600	1,500
JT	J05	5	6	11	7.2	1,000	1,000	1,000	2,000	1,200
JU	J06		7.2	13	7.2	1,000	1,000	800	1,600	-
JH	J11		4.5	6	7.2	1,000	1,000	1,500	3,000	1,700
JK	J12		5.5	7	7.2	1,000	1,000	1,200	2,400	1,300
JR	J13		6.5	8	7.2	1,000	1,000	900	1,800	1,100

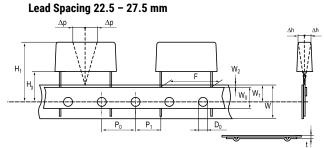


Lead Taping & Packaging (IEC 60286-2)

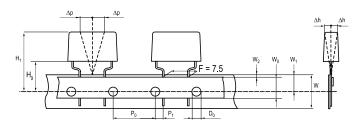








Formed Leads from 10 and 15 mm to 7.5 mm



Taping Specification

	Dimensions in mm												
Lead Spacing	+0.6/-0.1	F	5	7.5	Formed 7.5	10	15	22.5	27.5	F			
Carrier Tape Width	±0.5	W	18	18	18	18	18	18	18	18+1/-0.5			
Hold-down Tape Width	Minimum	W _o	5	5	5	5	5	5	5				
Position of Sprocket Hole	±0.5	W ₁	9	9	9	9	9	9	9	9+0.75/-0.5			
Distance Between Tapes	Maximum	W ₂	3	3	3	3	3	3	3	3			
Sprocket Hole Diameter	±0.2	D_{o}	4	4	4	4	4	4	4	4			
Feed Hole Lead Spacing	±0.3	P ₀ (1)	12.7	12.7	12.7 (4)	12.7	12.7	12.7	12.7	12.7			
Distance Lead - Feed Hole	±0.7	P ₁	3.85	3.75	3.75	7.7	5.2	5.3	5.3	P1			
Deviation Tape - Plane	Maximum	Δр	1.3	1.3	1.3	1.3	1.3	1.3	1.3	1.3			
Lateral Deviation	Maximum	Δh	2	2	2	2	2	2	2	2			
Total Thickness	±0.2	t	0.7	0.7	0.7	0.7	0.7	0.9 Maximum	0.9 Maximum	0.9 Maximum			
Sprocket Hole/Cap Body	Nominal	H ₀ (2)	18.5±0.5	18.5±0.5	18.5±0.5	18.5±0.5	18.5±0.5	18.5±0.5	18.5±0.5	18.0+2/-0			
Sprocket Hole/ Top of Cap Body	Maximum	H ₁ (3)	32	31	43	43	43	58	58	58 Maximum			

⁽¹⁾ Maximum cumulative feed hole error, 1 mm per 20 parts

^{(2) 16.5} mm available on request

⁽³⁾ Depending on case size

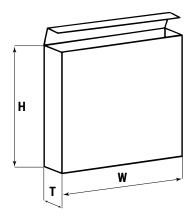
^{(4) 15} mm available on request



Lead Taping & Packaging (IEC 60286-2) cont.

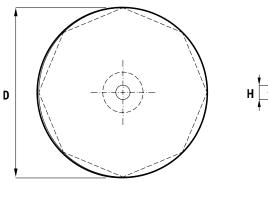
Ammo Specifications

Carias	Dimensions (mm)		
Series	Н	W	Т
R4x, R4x+R, R7x, RSB			
F5A, F5B, F5D	360	340	59
F6xx, F8xx			
PHExxx, PMExxx, PMRxxx, SMR & PFR	330	330	50



Reel Specifications

Carias	Dimensions (mm)		
Series	D	Н	W
R4x, R4x+R, R7x, RSB	055	0.0	
F5A, F5B, F5D	355 500	30 25	55 (Max)
F6xx, F8xx	300	23	
PHExxx, PMExxx, PMRxxx, SMR & PFR	360 500	30	46 (Max)



Manufacturing Date Code (IEC-60062)

Y = Year, Z = Month					
Year	Code	Month	Code		
2010	А	January	1		
2011	В	February	2		
2012	С	March	3		
2013	D	April	4		
2014	E	May	5		
2015	F	June	6		
2016	Н	July	7		
2017	J	August	8		
2018	K	September	9		
2019	L	October	0		
2020	M	November	N		
2021	N	December	D		
2022	Р				
2023	R				
2024	S				
2025	T				
2026	U				
2027	V				
2028	W				
2029	Χ				
2030	Α				



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